

2.4-5.5Vdc Input, 3A, 0.7525-3.63Vdc Output

The Series of non-isolated dc-dc converters deliver exceptional electrical and thermal performance in industry-standard footprints for Point-of-Load converters. Operating from a 2.4Vdc-5.5Vdc input, these are the converters of choice for Intermediate Bus Architecture (IBA) and Distributed Power Architecture applications that require high efficiency, tight regulation, and high reliability in elevated temperature environments with low airflow.

非絶縁型DC/DCコンパータの Stars シリースは業界標準のPOLコンパータ と同じ端子配列で極めて優れた電気的特性、及び温度特性を提供します。

入力電圧2.4V-5.5Vで動作しますので、このコンパータは、高効率、高い出力電圧精度、高温、及び風量の少ない環境での高信頼性が要求される IBA、又はDPAでの使用に最適です。

The **FPMR05TR7503*A** converter of the Series delivers 3A of output current at a tightly regulated programmable output voltage of 0.7525Vdc to 3.63Vdc. The thermal performance of the **FPMR05TR7503*A** is best-in-class: No derating is needed up to 85 , under natural convection.

 シリース の FPMR05TR7503*Aは高い電圧精度で0.7525V ~
 3.63Vの可変を実現します。FPMR05TR7503*Aの温度特性はクラス最高レ ^ ルです。自然対流条件で85 までティレーティンクを必要としません。

This leading edge thermal performance results from electrical, thermal and packaging design that is optimized for high density circuit card conditions. Extremely high quality and reliability are achieved through advanced circuit and thermal design techniques and FDK's state of the art in-house manufacturing processes and systems.

回路設計、放熱設計、及びバッケージンク 設計の結果である最先端の温 度特性は、高密度実装回路用に最適化されています。非常に優れた品 質と信頼性は高度な回路設計、温度設計技術、及びFDKの最先端の 自社製造プロセスによりもたらされます。

Applications

- Intermediate Bus Architecture 中間パス構成システム
- Telecommunications
 ₇
 ₇
 ₂
 ₂
- Data/Voice processing データ処理システム
- Distributed Power Architecture 分散型電源システム
- Computing (Servers, Workstations) コンビュータ関係(サーバー、ワークステーション)



FPMR05TR7503*A

Features

- RoHS compliant RoHS準拠
- Delivers up to 3A (10.89W) 3A (10.89W)まで供給可能
- High efficiency, no heatsink required 高効率-放熱器が不要
- No derating up to 85
 85 までディレーティング不要
- Negative and Positive ON/OFF logic ON/OFFロジ ックはネガ ティブ とボ ジ ティブ
- Industry-standard SIP pin-out 業界標準のSIPビンレイアウト
- Small size and low profile: 0.90" x 0.40" x 0.195" nominal
 - 小型、低背 (22.9 x 10.2 x 4.95mm)
- Programmable output voltage via external resistor 外部接続の抵抗によりプログラム可能な出力電圧
- No minimum load required 最小負荷は不要
- Start up into pre-biased output 出力にブリバイアスがあっても起動可能
- Remote ON/OFF
 リモートON/OFF機能
- Auto-reset output over-current protection 過電流保護機能: 自動復帰
- Auto-reset over-temperature protection 内部加熱保護機能: 自動復帰
- High reliability, MTBF = 1 Million Hours 高信頼性: MTBF = 1 Million Hours
- UL60950 recognition in U.S. & Canada, and CB Scheme certification per IEC/EN 60950(Pending) UL60950, CB Scheme取得(予定)
- All materials meet UL94, V-0 flammability rating 全ての部品は UL94 V-0に適合





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Electrical Specifications 電気的仕様

All specifications apply over specified input voltage, output load, and temperature range, unless otherwise noted.

注記が無い場合、全ての仕様は指定された入力電圧、負荷、温度範囲で適用されます。

Conditions: Ta=25degC, Airflow=200LFM (1.0m/s), Vin=5.0Vdc, unless otherwise specified.

PARAMETER	NOTES	MIN	ТҮР	MAX	UNITS
ABSOLUTE MAXIMUM RATINGS ¹					
Input Voltage	Continuous	-0.3		6.0	Vdc
Operating Temperature	Ambient temperature	-40		85	°C
Storage Temperature		-55		125	°C
Output Voltage		0.7525		3.63	Vdc
FEATURE CHARACTERISTICS					
Switching Frequency			300		
Output Voltage Programming Range	By external resistor. See trim table-1	0.7525		3.63	Vdc
Turn-On Delay Time	Full resistive load				
with Vin (module enabled, then Vin applied)	From Vin=Vin(min) to 0.1*Vout(nom)		5		ms
with Enable (Vin applied, then enabled)	From enable to 0.1*Vout(nom)		5		ms
Rise Time (Full resistive load)	From 0.1*Vout(nom) to 0.9*Vout(nom)		5		ms
ON/OFF Control (Negative Logic)	See Page26. Part Numbering Scheme				
Module Off		2.4		Vin	Vdc
Module On		-5.0		0.8	Vdc
ON/OFF Control (Positive Logic)	See Page26. Part Numbering Scheme				
Module Off		-5.0		Vin-1.6	Vdc
Module On		Vin-0.8		Vin	Vdc

¹Absolute Maximum Ratings 絶対最大定格

Stresses in excess of the absolute maximum ratings may lead to degradation in performance and reliability of the converter and may result in permanent damage. 絶対最大定格を超えたストレスは、性能の低下、長期信頼性の低下、及びモシュールの破損を引き起こすことがあります。





2.4-5.5Vdc Input, 3A, 0.7525-3.63Vdc Output

Electrical Specifications (Continued) 電気的仕様 (続き)

Conditions: Ta=25degC, Airflow=200LFM (1.0m/s), Vin=5.0Vdc, unless otherwise specified.

PARAMETER	NOTES	MIN	ТҮР	MAX	UNITS
INPUT CHARACTERISTICS					
Operating Input Voltage Range	Vout 1.8V	2.4	5.0	5.5	Vdc
	1.8V < Vout 2.5V	3.3	5.0	5.5	Vdc
	Vout > 2.5V	4.5	5.0	5.5	Vdc
Input Under Voltage Lockout					
Turn-on Threshold			2.2	2.4	Vdc
Turn-off Threshold		1.95	2.1		Vdc
Maximum Input Current	3Aout at Vin min				
	Vout=3.3V			2.4	Adc
	Vout=2.5V			2.5	Adc
	Vout=2.0V			2.1	Adc
	Vout=1.8V			2.5	Adc
	Vout=1.5V			2.1	Adc
	Vout=1.2V			1.8	Adc
	Vout=1.0V			1.5	Adc
	Vout=0.7525V			1.2	Adc
Input Stand-by Current (module disabled)			2		mA
Input No Load Current	Vout=3.3V		52		mA
	Vout=2.5V		58		mA
	Vout=2.0V		54		mA
	Vout=1.8V		52		mA
	Vout=1.5V		48		mA
	Vout=1.2V		42		mA
	Vout=1.0V		38		mA
	Vout=0.7525V		33		mA
Input Reflected-Ripple Current	See Fig. G for setup (BW=20MHz)		20		mAp-p





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Electrical Specifications (Continued) 電気的仕様 (続き)

Conditions: Ta=25degC, Airflow=200LFM (1.0m/s), Vin=5.0Vdc, unless otherwise specified.

PARAMETER	NOTES	MIN	ТҮР	MAX	UNITS
OUTPUT CHARACTERISTICS					
Output Voltage Set Point (no load)		-1.5	Vout	+1.5	%Vout
Output Regulation					
Over Line	Full resistive load		+/- 0.3		%Vout
Over Load	From no load to full load		+/- 0.5		%Vout
Output Voltage Range (Over all operating input voltage, resistive load and temperature conditions until end of life)		-2.5		+2.5	%Vout
Output Ripple and Noise BW=20MHz	Over line, load and temperature (Fig. F)				
Peak to Peak	Vout=3.3Vdc		20	40	mVp-p
External Load Capacitance	Plus full load (resistive)				
Min ESR > 1mΩ				1000	μF
Min ESR > 10mΩ				2000	μF
Output Current Range		0		3	А
Output Current Limit Inception (lout)	Vout=3.3Vdc		9.6		А
Output Short-Circuit Current	Short=10mΩ, Vout=3.3Vdc set		3.5		Arms
DYNAMIC RESPONSE					
lout step from 1.5A to 3A with di/dt= 5A/µS	Co=47µF x 2 ceramic + 1µF ceramic		80		mV
Setting time (Vout < 10% peak deviation)			20		μs
lout step from 3A to 1.5A with di/dt= -5A/µS	Co=47µF x 2 ceramic + 1µF ceramic		80		mV
Setting time (Vout < 10% peak deviation)			20		μs
EFFICIENCY	Full load (3A)				
	Vout=3.3Vdc		95.0		%
	Vout=2.5Vdc		93.0		%
	Vout=2.0Vdc		91.5		%
	Vout=1.8Vdc		91.0		%
	Vout=1.5Vdc		90.0		%
	Vout=1.2Vdc		88.5		%
	Vout=1.0Vdc		87.0		%
	Vout=0.7525Vdc		84.0		%





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Operation

Input and Output Impedance

FPMR05TR7503*A converter The should be connected to a DC power source using a low impedance input line. In order to counteract the possible effect of input line inductance on the stability of the converter, the use of decoupling capacitors placed in close proximity to the converter input pins is recommended. This will ensure stability of the converter and reduce input ripple voltage. Although low ESR Tantalum or other capacitors should typically be adequate, very low ESR capacitors (ceramic, over 200µF) are recommended to minimize input ripple voltage. The converter itself has on-board internal input capacitance of 5x2.2µF with very low ESR (ceramic).

FPMR05TR7503*Aと入力電源間は低インビータンスで接続してください。コ ンパータの安定性に影響のある入力インタウタンスを抑えるため、コンパータの 入力ビンの近傍にデカップリングコンデンサを付加することをお勧めします。こ れによりコンパータの安定動作を確実にし、入力リップル電圧を抑制します。 低ESRタンタル、又はその他のコンデンサも一般的には問題ありませんが、 入力リップルを最小にするためには、非常に低ESRコンデンサ(セラミックで200 µF以上)を推奨します。コンパータ自身は入力回路に極低ESRの5x2.2µF セラミック入力コンデンサを搭載しています。

The **FPMR05TR7503*A** is capable of stable operation with no external capacitance on the output. To minimize output ripple voltage, the use of very low ESR ceramic capacitors is recommended. These capacitors should be placed in close proximity to the load to improve transient performance and to decrease output voltage ripple.

FPMR05TR7503*Aは出力に外付けコンテンサが無い状態でも安定して動作します。出力リップルを最小にするため、極低ESRのセラミックコンテンサの接続を推奨します。過渡時の特性向上と出力リップル低減のために負荷の近傍に極低ESRセラミックコンテンサを実装することをお勧めします。

Note that the converter does not have a SENSE pin to counteract voltage drops between the output pins and the load. The impedance of the line from the converter output to the load should thus be kept as low as possible to maintain good load regulation.

このコンパータは出力端子と負荷間の電圧トロップを補正するセンス端子を設けていません。精度の高い負荷特性を保持するために、コンパータの出力から負荷までのラインインビーダンスは可能な限り低くしてください。



R* is for negative logic option only

Fig. A: Circuit configuration for remote ON/OFF

ON/OFF (Pin 5)

The ON/OFF pin (pin 5) can be used to turn the converter on or off remotely using a signal that is referenced to GND (pin 3), as shown in Fig. A.

Two remote control options are available, corresponding to negative and positive logic. In the negative logic option, to turn the converter on Pin 5 should be at logic low or left open, and to turn the converter off Pin 5 should be at logic high or connected to Vin. In the positive logic option, to turn the converter on Pin 5 should be at logic high, connected to Vin or left open, and to turn the converter off Pin 5 should be at logic high,

ON/OFF端子(5番ビン)は図Aのように、ケランド(3番ビン)を基準としたリモート 信号によりコンパータをON/OFFするのに使われます。 ネガティブとボジティブ ロジックに対応するため、2種類のリモートコントロールを選択可能です。 ネガティブオブションの場合、コンパータをONするには5番ビンをLowレヘル、又は 未接続とし、コンパータをOFFするには5番ビンをHighレヘル、又はVinと接続 とします。ボジティブオブションの場合、コンパータをONするには5番ビンをHighレ ヘル、Vinに接続、又は未接続とし、コンパータをOFFするには5番ビンをLow レヘルにします。

For a positive logic option, the ON/OFF pin (pin5) is internally pulled-up to Vin. An open collector (open -drain) transistor can be used to drive Pin 5. The device driving Pin 5 must be capable of: (a) Sinking up to 0.4mA at low logic level ボジティブオブションの場合、ON/OFFビン(5番ビン)はモジュール内部でVinlcブル アッブされています。オーブンコレクタ(オーブンドレイン)のトランジスタが5番ビンの操 作に使用可能です。 5番ビンを操作するデバイスには下記能力が必要です。 (a) Lowレベルで0.4mA程度のシンク能力

For a negative logic option, the ON/OFF pin (pin5) is internally pulled-down. A TTL or CMOS logic gate, or an open collector (open-drain) transistor can be used to drive Pin 5. When using an open collector (open -drain) transistor, a pull-up resistor, $R^*=5k\Omega$, should be connected to Vin (See Fig.A).

The device driving Pin 5 must be capable of:

(b) Sinking up to 1.2mA at low logic level (0.8V)
 (c) Sourcing up to 0.25mA at high logic level (2.3–5V)
 ネカ ティブ オブ ションの場合、ON/OFFビン(5番ビン)はモジュール内部でブルダウンされています。TTL、CMOSロジック、又はオーブンコレクタのトランジ スタセ5番ビンの操作に使用可能です。オーブンコレクタのトランジ スタを使用する時は5kのフールアップ抵抗をVinに接続してください。(図A参照)
 5番ビンを操作するデ パイスには下記能力が必要です。
 (b) 0.8V以下のLowレヘルで1.2mAまでのシンク能力
 (c) 2.3V-5VのHighロジックレヘルで0.25mAまでの供給能力



2.4-5.5Vdc Input, 3A, 0.7525-3.63Vdc Output

Output Voltage Programming (Pin 2)

The output voltage of the **FPMR05TR7503*A** converter can be programmed from 0.7525V to 3.63V by using an external resistor or a voltage source.

FPMR05TR7503*Aの出力電圧は外部抵抗を接続するか、又は外部電源を印加することで 0.7525V ~ 3.63Vまで可変可能です。

External Resistor

An external trim resistor, R_{TRIM} , should be connected between TRIM (pin 2) and GND (pin 3); see Fig. B. The value of R_{TRIM} , in k Ω , for a desired output voltage, V_{O-REQ} , in V, is given by:

外部抵抗 R_{TRM}はTRIM端子(2番ビン)とGND端子(3番ビン)の間に接続してください。図Bを参照。 R_{TRM}の定数、及び必要な出力電圧は次の式により求めます。

$$R_{\text{TRIM}} = \frac{21.07}{(V_{\text{O-REQ}} - 0.7525)} - 5.11 \text{ [k]}$$

Note that the tolerance of a trim resistor will affect the tolerance of the output voltage. Standard 1% or 0.5% resistors may suffice for most applications; however, a tighter tolerance can be obtained by using two resistors in series instead of one standard value resistor.

Table 1 lists calculated values of R_{TRIM} for common output voltages. For each value of R_{TRIM} , Table 1 also shows the closest available standard resistor value.

R_{TRM}の公差は出力電圧の公差に影響します。ほとんどの使用状況に おいては、標準的な1%又は0.5%品の抵抗で十分です。しかしながら、よ り厳しい出力精度のためには、抵抗1本よりも2本を直列に使用します。 Table 1に一般的な出力電圧を設定する際の抵抗値を表示します。また Table 1に標準的な抵抗を使用した場合の近似値も表示しています。



Fig. B: Configuration for programming output voltage

Table 1: Trim Resistor Value						
V _{O-REG} [V]	R _{TRIM} [kΩ]	The Closest Standard Value [kΩ]				
0.7525	Open					
1.0	80.02	80.6				
1.2	41.97	42.2				
1.5	23.08	23.2				
1.8	15.00	15.0				
2.0	11.78	11.8				
2.5	6.95	6.98				
3.3	3.16	3.16				
3.63	2.21	2.21				

External Voltage Source

To program the output voltage using an external voltage source, a voltage, V_{CTRL} , should be applied to the TRIM pin. Use of a series resistor, R_{EXT} , between the TRIM pin and the programming voltage source is recommended to make trimming less sensitive.

外部電源を使って出力電圧を可変するには、TRIM端子にV_{CTRL}の電圧 を印加します。電圧設定が敏感すぎるのを避けるため、TRIM端子と外 部電源間に抵抗を直列に接続することをお勧めします。

The voltage of the control voltage V_{CTRL}, in V, for a given value of R_{EXT}, in k Ω , is given by: V_{CTRL}電圧は下記の式により算出が可能です。

$$V_{\text{CTRL}} = 0.7 - \frac{(5.11 + R_{\text{EXT}})(V_{\text{O-REQ}} - 0.7525)}{30.1} \quad [V]$$

Table 2 lists values of V_{CTRL} for $R_{\text{EXT}}\text{=}0$ and $R_{\text{EXT}}\text{=}15k\Omega.$

Table 2はR_{EXT}=0の時とR_{EXT}=15kの時のV_{CTRL}電圧を表しています。

Table 2: Control Voltage [Vdc]						
V _{O-REG} [V]	V _{CTRL} (R _{EXT} =0)	V _{CTRL} (R _{EXT} =15k)				
0.7525	0.700	0.700				
1.0	0.658	0.535				
1.2	0.624	0.401				
1.5	0.573	0.201				
1.8	0.522	0.000				
2.0	0.488	-0.133				
2.5	0.403	-0.468				
3.3	0.268	-1.002				
3.63	0.212	-1.223				





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Protection Features

Input Under-Voltage Lockout

From a turned-on state, the converter will turn off automatically when the input voltage drops below typically 2.1V. It will then turn on automatically when the input voltage reaches typically 2.2V.

動作している状態で入力電圧がTYPで2.1V未満になると、このコンパータ は自動的に停止します。また、入力電圧がTYPで2.2V以上になると、こ のコンパータは自動的に動作を開始します。

Output Over-Current Protection (OCP)

The converter is self-protected against over-current and short circuit conditions. On the occurrence of an over-current condition, the converter will enter a pulse-by-pulse hiccup mode. On the removal of the over-current or short circuit condition, Vout will return to the original value (auto-reset).

このコンパータは過電流と短絡に対し自己保護します。過電流状態になると、このコンパータはパルス-パイ-パルス HICCUPモードになり、過電流状態が 解除されるとVoutは通常の値に戻ります。(自動リセット)

Over-Temperature Protection (OTP)

The converter is protected against over-temperature conditions, using a built-in thermal protection feature in the PWM controller IC. In case of overheating due to abnormal operation conditions, the converter will turn off automatically. It will turn back on automatically once it has cooled down to a safe temperature (auto-reset).

このコンパータはPWMコントロールICの持っている温度保護機能を使って加熱 状態から保護されています。異常な動作条件などにより加熱保護が動 作すると、コンパータは自動的に停止します。安全な温度まで下がると、自 動的に再起動します。(自動リセット)

Alternatively, Option additionally incorporates an independent OTP function with higher precision than that provided by the controller IC. In case of overheating due to abnormal operation conditions, the converter will turn off automatically. It will turn back on automatically once it has cooled down to a safe temperature (auto-reset).

他の方法として、オブションでコントロールICよりも精度の高い独立したOTP機能を付加することができます。異常な動作条件などにより加熱保護が動作すると、コンパータは自動的に停止します。安全な温度まで下がると、自動的に再起動します。(自動リセット)

Safety Requirements

The converter meets North American and International safety regulatory requirements per UL60950 and EN60950. (Pending) The converter SELV meets (safety extra-low voltage) requirements under normal operating conditions in that the output voltages are ELV (extra- low voltage) when all the input voltages are ELV. Note that the converter is not internally fused: to meet safety requirements, a fast acting in-line fuse with a maximum rating of 5A must be used in the positive input line.

このコンパータはUL60950とEN60950による北米、及び国際的な安全基準 を満たしています。(予定)このコンパータは通常の動作条件下において SELVの条件を満たしており、入力電圧がELVであれば出力電圧もELV となります。但し、このコンパータは内部にヒューズを持っていませんので、 安全規格に適合させるためには、入力ラインのプラス側に即断型で最大定 格5Aのヒューズを接続してください。



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Characterization

Overview

The converter has been characterized for several operational features, including thermal derating (maximum available load current as a function of ambient temperature and airflow), efficiency, power dissipation, start-up and shutdown characteristics, ripple and noise, and transient response to load step-changes.

このコンパータは温度ディレーティンク、効率、電力損失、スタートアップ時、及び シャットダウン時の動作、リップル・ノイズ、動的負荷変動などを含む、さまざま な動作状態で特徴付けられます。

Figures showing data plots and waveforms for different output voltages are presented in the following pages. The figures are numbered as Fig.*V-#, where *V indicates the output voltage, and # indicates a particular plot type for that voltage. For example, Fig *V-2 is a plot of efficiency vs. load current for any output voltage *V.

各出力電圧時のデータ、及び波形の図は以後のベージに掲載されています。図はFig *V-#のように番号付けされており、*Vは出力電圧を表し、 #は特定のプロットを表します。例えば Fig *V-2とあれば、*V出力での効 率特性を表します。

Test Conditions

To ensure measurement accuracy and reproducibility, all thermal and efficiency data were taken with the converter soldered to a standardized thermal test board. The thermal test board was mounted inside FDK's custom wind tunnel to enable precise control of ambient temperature and airflow conditions.

測定精度、及び再現性を確実にするために、全ての温度、及び効率 データは標準化された温度評価ボードにコンバータを半田付けして取得して います。温度評価ボードをFDK特製の風洞実験設備内に設置すること で、環境温度、及び風量を精密に管理しています。

The thermal test board comprised a four layer printed circuit board (PCB) with a total thickness of 0.060".

Copper metallization on the two outer layers was limited to pads and traces needed for soldering the converter and peripheral components to the board. The two inner layers comprised power and ground planes of 2 oz. copper. This thermal test board, with the paucity of copper on the outer surfaces, limits heat transfer from the converter to the PCB, thereby providing a worst-case but consistent set of conditions for thermal measurements.

温度評価ボードは厚さ0.060"(1.6mm)厚の4層PCBで作成しています。表面2層の銅箔はコンパータを実装するためのパッドと周辺部品へのパターンのみに限定しています。内側2層は70μmの銅箔で電力、及びグランドラインを形成しています。このように表層の銅箔を限りなく少なくした温度評価ボードは、コンパータからPCBへの熱の逃げを制限し、ワーストケースでありながら矛盾の無い温度評価条件を実現しています。



Fig. C: FDK Original Wind Tunnel



Fig. D: Test Chamber

FDK's custom wind tunnel was used to provide precise horizontal laminar airflow in the range of 50 LFM to 600LFM, at ambient temperatures between 30°C and 85°C. Infrared (IR) thermography and thermocouples were used for temperature measurements. (See Fig. C & Fig. D)

FDK特製の風洞実験装置は水平方向の層流を50LFM(自然対流と同等、NC)から600LFMまで精密に制御でき、環境温度は30 から85 を 制御できます。温度測定には赤外線(IR)サーモグラフィと熱電対を使用して います。(図C及び図D参照)

It is advisable to check the converter temperature in the actual application, particularly if the application calls for loads close to the maximums specified by the derating curves. IR thermography or thermocouples may be used for this purpose. In the latter case, AWG#40 gauge thermocouples are recommended to minimize interference and measurement error. An optimum location for placement of a thermocouple is indicated in Fig. E.

コンパータの温度を実際の使用環境で測定することをお勧めします。特に 実使用上の負荷が温度ティレーティンクの最大値に近い場合は測定が必 要です。温度測定には赤外線サーモクラフィ、又は熱電対をお使いいただ けます。熱電対を使用する場合、風の妨げになることを防ぐためと、測 定誤差を少なくするため、AWG40の熱電対を推奨します。熱電対での 測定に最適な箇所は図Eに示します。





2.4-5.5Vdc Input, 3A, 0.7525-3.63Vdc Output

Thermal Derating

Figs *V-1 show the maximum available load current vs. ambient temperature and airflow rates. Ambient temperature was varied between 30°C and 85°C, with airflow rates from NC(50LFM) to 400LFM (0.25m/s to 2.0m/s). The converter was mounted vertically, and the airflow was parallel to the long axis of the converter, going from pin 1 to pin 5.

図 *V-1はある環境温度と風量の条件下における最大出力電流を表します。環境温度は風量NC(50LFM)~400LFMの条件で30 ~85 の間を変動させています。コンパータは垂直に設置し、風向きはコンパータの長手方向に平行で1番ビンから5番ビンに向けて吹いています。

The maximum available load current, for any given set of conditions, is defined as the lower of:

(i) The output current at which the temperature of any component reaches 120°C, or

(ii) The current rating of the converter (3A)

A maximum component temperature of 120°C should not be exceeded in order to operate within the derating curves. Thus, the temperature at the thermocouple location shown in Fig. E should not exceed 120°C in normal operation.

各々の測定条件で最大出力電流の値は下記のとおり定義します。 (i) いずれかの部品の温度が120 に到達した時点の出力電流値又は (ii) コンパータの公称定格電流 (3A)

温度ディレーティンヴの範囲内で動作させるために、部品温度は120 を超 えないようにご注意ください。従って、通常動作時に図Eに示す位置の 熱電対の温度が120 を超えないようにしてください。

Note that continuous operation beyond the derated current as specified by the derating curves may lead to degradation in performance and reliability of the converter and may result in permanent damage.

出力電流ディレ-ティングカーブで指定された定格電流を超えた連続した操作は、性能の低下、信頼性の低下、及びモジュールの破損を引き起こすことがあります



Fig.E: Location of the thermocouple for thermal testing

Ripple and Noise

The test circuit setup shown in Fig. F was used to obtain the output voltage ripple. And Fig. G was used to obtain the input reflected ripple current waveforms. The output voltage ripple waveform was measured across a 1µF ceramic capacitor at full load current. 図Fに示す試験回路は出力リッブルの測定に使用しており、入力リッブルの測定には図Gの試験回路を使用しています。全ての出力リッブル波形は1 µFのセラミックコンデンサを付けて測定しています。







Fig. G: Test setup for measuring input reflected ripple current





2.4-5.5Vdc Input, 3A, 0.7525-3.63Vdc Output



Fig-3.3V-1: Available load current vs. ambient temperature and airflow rates for Vout=3.3V with Vin=5.0V. Maximum component temperature 120°C



Fig-3.3V-2: Efficiency vs. load current and input voltage for Vout=3.3V. Airflow rate=200 LFM (1.0m/s) and Ta=25°C.



Fig-3.3V-3: Power dissipation vs. load current and input voltage for Vout=3.3V. Airflow rate=200 LFM (1.0m/s) and Ta=25°C.



2.4-5.5Vdc Input, 3A, 0.7525-3.63Vdc Output



Fig-3.3V-4: Turn-on transient for Vout=3.3V with application of Vin at full rated load current (resistive) and 47μ Fx2 external capacitance at Vin=5.0V. Top trace: Vin (5V/div.)

Bottom trace: output voltage (1V/div.) Time scale: 2ms/div.



Fig-3.3V-5: Output voltage ripple (20mV/div.) for Vout=3.3V at full rated load current into a resistive load with external capacitance 47μ Fx2 ceramic + 1μ F ceramic at Vin=5.0V. Time scale: 2μ s/div



Fig-3.3V-6: Output voltage response for Vout=3.3V to positive load current step-change from 1.5A to 3A with slew rate of $3A/\mu s$ at Vin=5.0V. Co= $47\mu Fx2$ ceramic.

Top trace: output voltage (100mV/div.) Bottom trace: load current (2A/div.) Time scale: 20µs/div.



Fig-3.3V-7: Output voltage response for Vout=3.3V to negative load current step-change from 3A to 1.5A with slew rate of $-5A/\mu s$ at Vin=5.0V. Co=47 μ Fx2 ceramic. Top trace: output voltage (100mV/div.) Bottom trace: load current (2A/div.) Time scale: 20 μ s/div.







Fig-2.5V-1: Available load current vs. ambient temperature and airflow rates for Vout=2.5V with Vin=5.0V. Maximum component temperature 120°C



Fig-2.5V-2: Efficiency vs. load current and input voltage for Vout=2.5V. Airflow rate=200 LFM (1.0m/s) and Ta=25°C.



Fig-2.5V-3: Power dissipation vs. load current and input voltage for Vout=2.5V. Airflow rate=200 LFM (1.0m/s) and Ta=25°C.



2.4-5.5Vdc Input, 3A, 0.7525-3.63Vdc Output



Fig-2.5V-4: Turn-on transient for Vout=2.5V with application of Vin at full rated load current (resistive) and 47μ Fx2 external capacitance at Vin=5.0V. Top trace: Vin (5V/div.) Bottom trace: output voltage (1V/div.) Time scale: 2ms/div.



Fig-2.5V-5: Output voltage ripple (20mV/div.) for Vout=2.5V at full rated load current into a resistive load with external capacitance 47μ Fx2 ceramic + 1μ F ceramic at Vin=5.0V. Time scale: 2μ s/div



Fig-2.5V-6: Output voltage response for Vout=2.5V to positive load current step-change from 1.5A to 3A with slew rate of $3A/\mu s$ at Vin=5.0V. Co= $47\mu Fx2$ ceramic.

Top trace: output voltage (100mV/div.) Bottom trace: load current (2A/div.) Time scale: 20µs/div.



Fig-2.5V-7: Output voltage response for Vout=2.5V to positive load current step-change from 3A to 1.5A with slew rate of $-5A/\mu s$ at Vin=5.0V. Co=47 μ Fx2 ceramic. Top trace: output voltage (100mV/div.) Bottom trace: load current (2A/div.)

Time scale: 20µs/div.







Fig-2.0V-1: Available load current vs. ambient temperature and airflow rates for Vout=2.0V with Vin=5.0V. Maximum component temperature 120°C



Fig-2.0V-2: Efficiency vs. load current and input voltage for Vout=2.0V. Airflow rate=200 LFM (1.0m/s) and Ta=25°C.



Fig-2.0V-3: Power dissipation vs. load current and input voltage for Vout=2.0V. Airflow rate=200 LFM (1.0m/s) and Ta=25°C.



2.4-5.5Vdc Input, 3A, 0.7525-3.63Vdc Output



Fig-2.0V-4: Turn-on transient for Vout=2.0V with application of Vin at full rated load current (resistive) and 47μ Fx2 external capacitance at Vin=5.0V. Top trace: Vin (5V/div.) Bottom trace: output voltage (1V/div.) Time scale: 2ms/div.



Fig-2.0V-5: Output voltage ripple (20mV/div.) for Vout=2.0V at full rated load current into a resistive load with external capacitance 47μ Fx2 ceramic + 1μ F ceramic at Vin=5.0V. Time scale: 2μ s/div



Fig-2.0V-6: Output voltage response for Vout=2.0V to positive load current step-change from 1.5A to 3A with slew rate of 3A/ μ s at Vin=5.0V. Co=47 μ Fx2 ceramic.

Top trace: output voltage (100mV/div.) Bottom trace: load current (2A/div.) Time scale: 20µs/div.



Fig-2.0V-7: Output voltage response for Vout=2.0V to positive load current step-change from 3A to 1.5A with slew rate of -5A/ μ s at Vin=5.0V. Co=47 μ Fx2 ceramic. Top trace: output voltage (100mV/div.) Bottom trace: load current (2A/div.) Time scale: 20 μ s/div.





Fig-1.8V-1: Available load current vs. ambient temperature and airflow rates for Vout=1.8V with Vin=5.0V. Maximum component temperature 120°C



Fig-1.8V-2: Efficiency vs. load current and input voltage for Vout=1.8V. Airflow rate=200 LFM (1.0m/s) and Ta=25°C.



Fig-1.8V-3: Power dissipation vs. load current and input voltage for Vout=1.8V. Airflow rate=200 LFM (1.0m/s) and Ta=25°C.



2.4-5.5Vdc Input, 3A, 0.7525-3.63Vdc Output



Fig-1.8V-4: Turn-on transient for Vout=1.8V with application of Vin at full rated load current (resistive) and 47μ Fx2 external capacitance at Vin=5.0V. Top trace: Vin (5V/div.) Bottom trace: output voltage (1V/div.) Time scale: 2ms/div.



Fig-1.8V-5: Output voltage ripple (20mV/div.) for Vout=1.8V at full rated load current into a resistive load with external capacitance 47μ Fx2 ceramic + 1μ F ceramic at Vin=5.0V. Time scale: 2μ s/div



Fig-1.8V-6: Output voltage response for Vout=1.8V to positive load current step-change from 1.5A to 3A with slew rate of 3A/ μ s at Vin=5.0V. Co=47 μ Fx2 ceramic.

Top trace: output voltage (100mV/div.) Bottom trace: load current (2A/div.) Time scale: 20µs/div.



Fig-1.8V-7: Output voltage response for Vout=1.8V to positive load current step-change from 3A to 1.5A with slew rate of -5A/ μ s at Vin=5.0V. Co=47 μ Fx2 ceramic. Top trace: output voltage (100mV/div.) Bottom trace: load current (2A/div.) Time scale: 20 μ s/div.







Fig-1.5V-1: Available load current vs. ambient temperature and airflow rates for Vout=1.5V with Vin=5.0V. Maximum component temperature 120°C



Fig-1.5V-2: Efficiency vs. load current and input voltage for Vout=1.5V. Airflow rate=200 LFM (1.0m/s) and Ta=25°C.



Fig-1.5V-3: Power dissipation vs. load current and input voltage for Vout=1.5V. Airflow rate=200 LFM (1.0m/s) and Ta=25°C.



2.4-5.5Vdc Input, 3A, 0.7525-3.63Vdc Output



Fig-1.5V-4: Turn-on transient for Vout=1.5V with application of Vin at full rated load current (resistive) and 47μ Fx2 external capacitance at Vin=5.0V. Top trace: Vin (5V/div.) Bottom trace: output voltage (1V/div.) Time scale: 2ms/div.



Fig-1.5V-5: Output voltage ripple (20mV/div.) for Vout=1.5V at full rated load current into a resistive load with external capacitance 47μ Fx2 ceramic + 1μ F ceramic at Vin=5.0V. Time scale: 2μ s/div



Fig-1.5V-6: Output voltage response for Vout=1.5V to positive load current step-change from 1.5A to 3A with slew rate of $3A/\mu s$ at Vin=5.0V. Co=47 μ Fx2 ceramic.

Top trace: output voltage (100mV/div.) Bottom trace: load current (2A/div.) Time scale: 20µs/div.



Fig-1.5V-7: Output voltage response for Vout=1.5V to positive load current step-change from 3A to 1.5A with slew rate of $-5A/\mu s$ at Vin=5.0V. Co=47 μ Fx2 ceramic. Top trace: output voltage (100mV/div.) Bottom trace: load current (2A/div.)

Time scale: 20µs/div.







Fig-1.2V-1: Available load current vs. ambient temperature and airflow rates for Vout=1.2V with Vin=5.0V. Maximum component temperature 120°C



Fig-1.2V-2: Efficiency vs. load current and input voltage for Vout=1.2V. Airflow rate=200 LFM (1.0m/s) and Ta=25°C.



Fig-1.2V-3: Power dissipation vs. load current and input voltage for Vout=1.2V. Airflow rate=200 LFM (1.0m/s) and Ta=25°C.





2.4-5.5Vdc Input, 3A, 0.7525-3.63Vdc Output



1 20.40 %

Fig-1.2V-4: Turn-on transient for Vout=1.2V with application of Vin at full rated load current (resistive) and 47μ Fx2 external capacitance at Vin=5.0V. Top trace: Vin (5V/div.) Bottom trace: output voltage (1V/div.) Time scale: 2ms/div.



Fig-1.2V-5: Output voltage ripple (20mV/div.) for Vout=1.2V at full rated load current into a resistive load with external capacitance 47μ Fx2 ceramic + 1μ F ceramic at Vin=5.0V. Time scale: 2μ s/div



Fig-1.2V-6: Output voltage response for Vout=1.2V to positive load current step-change from 1.5A to 3A with slew rate of $3A/\mu s$ at Vin=5.0V. Co= $47\mu Fx2$ ceramic.

Top trace: output voltage (100mV/div.) Bottom trace: load current (2A/div.) Time scale: 20µs/div.



Fig-1.2V-7: Output voltage response for Vout=1.2V to positive load current step-change from 3A to 1.5A with slew rate of $-5A/\mu s$ at Vin=5.0V. Co=47 μ Fx2 ceramic. Top trace: output voltage (100mV/div.) Bottom trace: load current (2A/div.) Time scale: 20 μ s/div.





Fig-1.0V-1: Available load current vs. ambient temperature and airflow rates for Vout=1.0V with Vin=5.0V. Maximum component temperature 120°C



Fig-1.0V-2: Efficiency vs. load current and input voltage for Vout=1.0V. Airflow rate=200 LFM (1.0m/s) and Ta=25°C.



Fig-1.0V-3: Power dissipation vs. load current and input voltage for Vout=1.0V. Airflow rate=200 LFM (1.0m/s) and Ta=25°C.



2.4-5.5Vdc Input, 3A, 0.7525-3.63Vdc Output



Fig-1.0V-4: Turn-on transient for Vout=1.0V with application of Vin at full rated load current (resistive) and 47μ Fx2 external capacitance at Vin=5.0V. Top trace: Vin (5V/div.) Bottom trace: output voltage (1V/div.) Time scale: 2ms/div.



Fig-1.0V-5: Output voltage ripple (20mV/div.) for Vout=1.0V at full rated load current into a resistive load with external capacitance 47μ Fx2 ceramic + 1μ F ceramic at Vin=5.0V. Time scale: 2μ s/div



Fig-1.0V-6: Output voltage response for Vout=1.0V to positive load current step-change from 1.5A to 3A with slew rate of $3A/\mu s$ at Vin=5.0V. Co= $47\mu Fx2$ ceramic.

Top trace: output voltage (100mV/div.) Bottom trace: load current (2A/div.) Time scale: 20µs/div.



Fig-1.0V-7: Output voltage response for Vout=1.0V to positive load current step-change from 3A to 1.5A with slew rate of $-5A/\mu s$ at Vin=5.0V. Co=47 μ Fx2 ceramic. Top trace: output voltage (100mV/div.)

Bottom trace: load current (2A/div.) Time scale: 20µs/div.





Fig-0.7525V-1: Available load current vs. ambient temperature and airflow rates for Vout=0.7525V with Vin=5.0V. Maximum component temperature 120°C



Fig-0.7525V-2: Efficiency vs. load current and input voltage for Vout=0.7525V. Airflow rate=200 LFM (1.0m/s) and Ta=25°C.



Fig-0.7525V-3: Power dissipation vs. load current and input voltage for Vout=0.7525V. Airflow rate=200 LFM (1.0m/s) and Ta=25°C.



2.4-5.5Vdc Input, 3A, 0.7525-3.63Vdc Output



Fig-0.7525V-4: Turn-on transient for Vout=0.7525V with application of Vin at full rated load current (resistive) and 47µFx2 external capacitance at Vin=5.0V. Top trace: Vin (5V/div.) Bottom trace: output voltage (1V/div.)

Time scale: 2ms/div.



11 Acqs

Tek Stop: 250MS/s

for Vout=0.7525V at full rated load current into a resistive load with external capacitance 47µFx2 ceramic + 1µF ceramic at Vin=5.0V. Time scale: 2µs/div



Fig-0.7525V-6: Output voltage response for Vout=0.7525V to positive load current step-change from 1.5A to 3A with slew rate of 3A/µs at Vin=5.0V. Co=47µFx2 ceramic. Top trace: output voltage (100mV/div.) Bottom trace: load current (2A/div.) Time scale: 20µs/div.



Fig-0.7525V-7: Output voltage response for Vout=0.7525V to positive load current step-change from 3A to 1.5A with slew rate of -5A/µs at Vin=5.0V. Co=47µFx2 ceramic. Top trace: output voltage (100mV/div.) Bottom trace: load current (2A/div.) Time scale: 20µs/div.



2.4-5.5Vdc Input, 3A, 0.7525-3.63Vdc Output

Mechanical Drawing







RECOMMENDED HOLE PATTERN

FRONT VIEW OF BOARD

Pin Connections				
Pin # Function				
1	Vout			
2	TRIM			
3	GND			
4	Vin			
5	ON/OFF			

Notes

- All dimensions are in millimeters (inches)

- Unless otherwise specified, tolerances are +/- 0.25mm
- Connector Material : Copper
- Connector Finish : Tin over nickel
- Converter Weight : 0.081oz (2.3g)
- Converter Height : 10.7mm Max
- Recommended Through Hole Via : φ1.20mm
- Recommended Pad Size : φ2.00mm

Part Numbering Scheme

Product Series	Shape	Regulation	Input Voltage	Mounting Scheme	Output Voltage	Rated Current	ON/OFF Logic	Pin Shape
FP	М	R	05	т	R75	03	*	Α
Series Name	Middle	R: Regulated	Typ=5V	Through Hole	0.75V (Programmable: See page 6)	3A	N: Negative P: Positive	A: Standard

Cautions

NUCLEAR AND MEDICAL APPLICATIONS: FDK Corporation products are not authorized for use as critical components in life support systems, equipment used in hazardous environments, or nuclear control systems without the written consent of FDK Corporation.

SPECIFICATION CHANGES AND REVISIONS: Specifications are version-controlled, but are subject to change without notice.